ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® MAterial Comp © Copyright 2005. I international and Par	PC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaratio	ration on encor	of the substan	ces wit	nin the manuf vel materials f	facturer listed for which the	item. I manuf	Note: if t acturer h	he item is an as as engineering	ssembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					faterials and N	Afg Inf	formation	1	
Supplier Information															
Company name* Con			Company unique ID			Unique ID Authority					Respon	Response Date*			
onsemi										2024-04	2024-04-25				
Contact Name	Title - Conta	Contact			Phone - Contact*					Email ·	Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title			Title - Representative			Phone - Representative*				Email ·	Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com					
Requester Item Number	n Number Mfr Item N		Number Mfr Item Name			Effective Da	ate V	resion	Manufacturing Site		te	Weig	ht*	UOM	Unit Type
	PCA965	PCA9655EDTR2G 16-BIT I/O		I/O EXPANDER		2024-04-25			PH1	PH1		69.68		mg	Each
Ianufacturing Proccess Informa	tion						1							ł	1
Terminal Plating / Grid Array M	aterial	Terminal Base A	Alloy	J-STD-020 MS	L Rating	Peak Process Bo		Body Temper	ody Temperature Max Time at Peak		Peak Tempera	Temperature Number of Refl		of Reflow Cyc	cles
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		nds	3		
omments															
vel 1 - maximum time at peak temperati	ire during so	ldering is 10-3	0 seconds												
or more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed								
Directive 2015/863/EU amending RoHS Directive 2011/65/EU													
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of								
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all								
Exemption List Version	EL-2011/534/EU												
Declaration Signature													
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the								
Supplier Digital Signature Ra	stislav Drska	Le											

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter [F] Optionally enter the positive (+) ar				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.12	mg	Supplier	Silicon (Si)	7440-21-3		3.12	mg
Die Attach	1.26	mg	Supplier	Silver (Ag)	7440-22-4		0.945	mg
			Supplier	Epoxy resins	129915-35-1		0.315	mg
Lead Frame	16.21	mg	Supplier	Iron (Fe)	7439-89-6		0.308	mg
			Supplier	Copper (Cu)	7440-50-8		15.902	mg
Mold Compound-Black	45.76	mg		Epoxy Phenol Resin	proprietary data		4.8048	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.9552	mg
Plating	2.91	mg	Supplier	Palladium (Pd)	7440-05-3		0.2212	mg
			В	Nickel (Ni)	7440-02-0		2.6481	mg
			Supplier	Gold (Au)	7440-57-5		0.0407	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg